

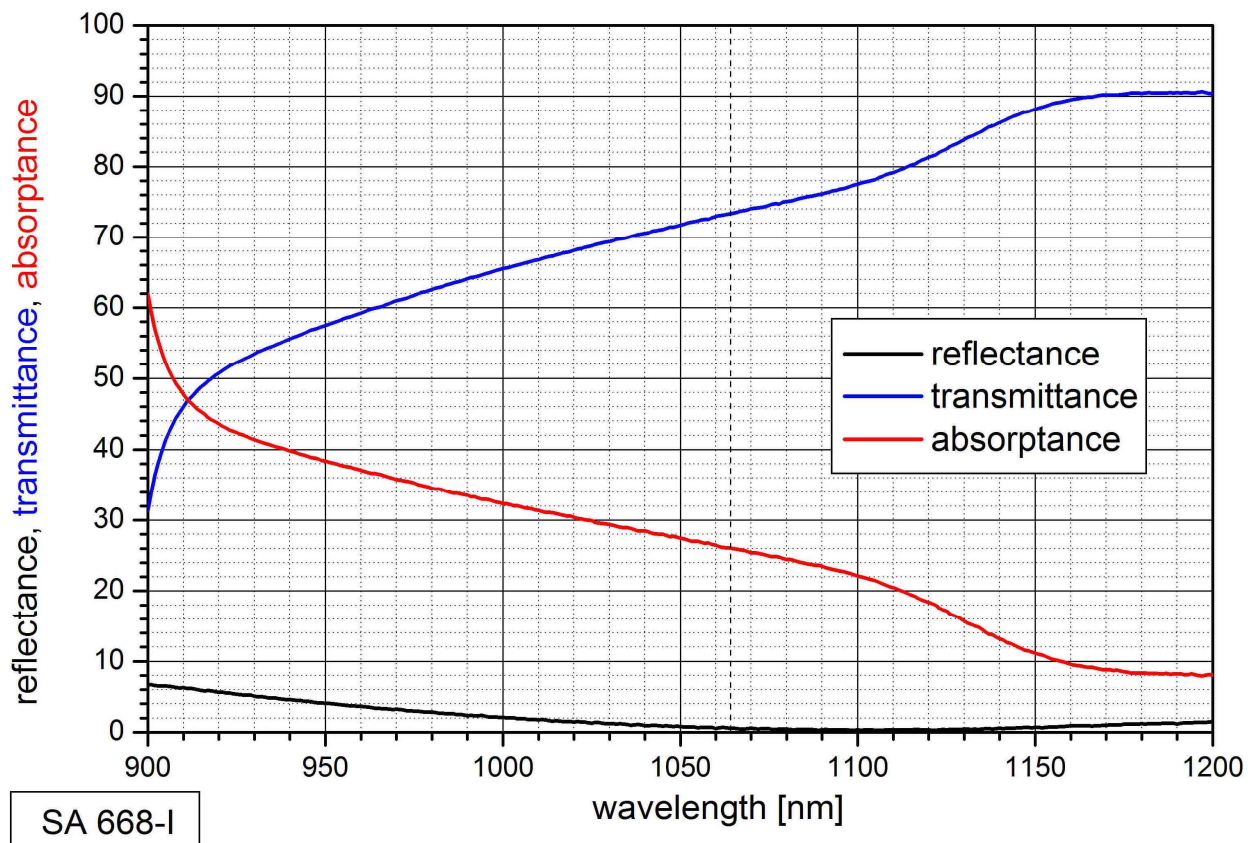
SA data sheet SA-1064-26-37ps-x, $\lambda = 1064 \text{ nm}$

Laser wavelength	$\lambda = 1000 \text{ nm} \dots 1100 \text{ nm}$
Absorptance	$A_0 = 26 \%$
Transmittance	$T = 73 \%$
Modulation depth	$\Delta T = 4.9 \%$
Saturation fluence	$\Phi_{\text{sat}} = 300 \mu\text{J}/\text{cm}^2$
Damage threshold	$\Phi = 1 \text{ mJ}/\text{cm}^2$
Relaxation time constant	$\tau \sim 37 \text{ ps}$
Chip area	5.0 mm x 5.0 mm; other dimensions on request
Chip thickness	625 μm ; semi-insulating GaAs
Front side protection	AR coating for 1064 nm
Back side coating	the SA back side is polished and antireflection coated for 1064 nm

Mounting of SA-1064-26-**x**-37ps denotes the type of mounting as follows:

x = 0	unmounted
x = 12.7 g	glued on a copper heat sink with 12.7 mm \varnothing and 4 mm \varnothing center hole
x = 25.4 g	glued on a copper heat sink with 25.4 mm \varnothing and 4 mm \varnothing center hole
x = FC	a back-thinned SA chip with 100 μm thickness is mounted inside a 1 m monomode fiber cable

low intensity reflectance, **absorptance** and **transmittance**



Relaxation time τ measurement